DISCRETE SEMICONDUCTORS

DATA SHEET

BLW30 VHF power transistor

Product specification

September 1991





BLW30

FEATURES

- Emitter-ballasting resistors for an optimum temperature profile
- · Excellent reliability
- Withstands full load mismatch.

DESCRIPTION

NPN silicon planar epitaxial transistor encapsulated in a 4-lead $^3/_8$ inch SOT120 capstan envelope with a ceramic cap. It is designed for common emitter, class-B operation mobile VHF transmitters with a supply voltage of 12.5 V. All leads are isolated from the stud.

PINNING - SOT120

| PIN | DESCRIPTION | | | | | | |
|-----|-------------|--|--|--|--|--|--|
| 1 | collector | | | | | | |
| 2 | emitter | | | | | | |
| 3 | base | | | | | | |
| 4 | emitter | | | | | | |

QUICK REFERENCE DATA

RF performance at T_{mb} = 25 °C in a common emitter test circuit.

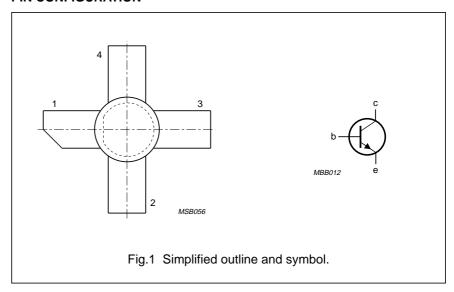
| MODE OF OPERATION | f | V _{CE} | P _L | G _P | ης |
|-------------------|-------|-----------------|----------------|----------------|------------|
| | (MHz) | (V) | (W) | (dB) | (%) |
| c.w. class-B | 175 | 12.5 | 30 | > 10 | > 55 |

WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

PIN CONFIGURATION

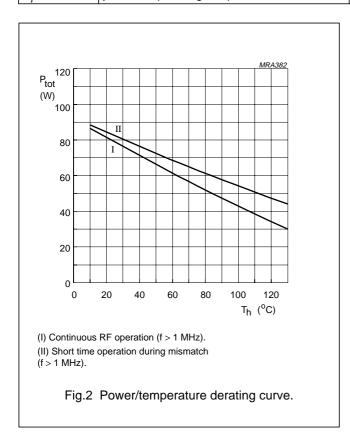


BLW30

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-------------------------------------|--------------------------------|--|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | _ | 36 | V |
| V_{CEO} | collector-emitter voltage | open base | _ | 16 | V |
| V _{EBO} | emitter-base voltage | open collector | _ | 3 | V |
| I _C , I _{C(AV)} | collector current | DC or average value | _ | 6 | А |
| I _{CM} | collector current | peak value f > 1 MHz | _ | 18 | А |
| P _{tot} | total power dissipation | RF operation; f > 1 MHz; T _{mb} = 25 °C | _ | 100 | W |
| T _{stg} | storage temperature range | | -65 | 150 | °C |
| Ti | junction operating temperature | | _ | 200 | °C |



THERMAL RESISTANCE

| SYMBOL | PARAMETER | CONDITIONS | MAX. | UNIT |
|--------------------------|--------------------------------|--|------|------|
| R _{th j-mb(RF)} | from junction to mounting base | $P_{tot} = 100 \text{ W};$ $T_{mb} = 25 ^{\circ}\text{C}$ | 1.75 | K/W |
| R _{th mb-h} | from mounting base to heatsink | | 0.45 | K/W |

BLW30

CHARACTERISTICS

 $T_j = 25$ °C.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------------|-------------------------------------|---|------|------|------|------|
| V _{(BR)CBO} | collector-base breakdown voltage | open emitter; I _c = 10 mA | 36 | _ | _ | V |
| V _{(BR)CEO} | collector-emitter breakdown voltage | open base; I _c = 25 mA | 16 | _ | _ | V |
| V _{(BR)EBO} | emitter-base breakdown voltage | open collector; I _E = 2 mA | 3 | _ | _ | V |
| I _{CES} | collector-emitter leakage current | V _{BE} = 0; V _{CE} = 16 V | _ | _ | 10 | mA |
| h _{FE} | DC current gain | V _{CE} = 5 V; I _C = 4 A | 25 | 35 | _ | |
| f _T | transition frequency | $V_{CE} = 12.5 \text{ V};$ $I_{E} = 4 \text{ A};$ $f = 500 \text{ MHz}$ | - | 1.6 | _ | GHz |
| C _c | collector capacitance | $V_{CB} = 12.5 \text{ V};$ $I_{E} = I_{e} = 0;$ $f = 1 \text{ MHz}$ | - | 90 | 100 | pF |
| C _{re} | feedback capacitance | $V_{CE} = 12.5 \text{ V};$ $I_{C} = 0;$ $f = 1 \text{ MHz}$ | - | 60 | 70 | pF |
| C _{c-s} | collector-stud capacitance | f = 1 MHz | _ | 2 | _ | pF |

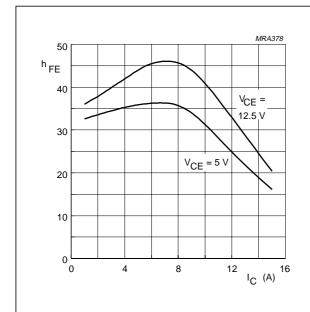
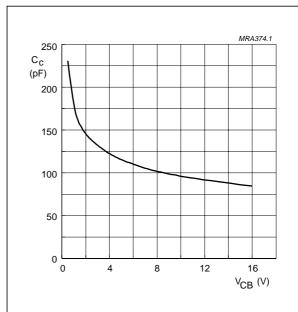


Fig.3 DC current gain as a function of collector current, typical values.



 $I_E = i_e = 0$; f = 1 MHz.

Fig.4 Collector capacitance as a function of collector-base voltage, typical values.

BLW30

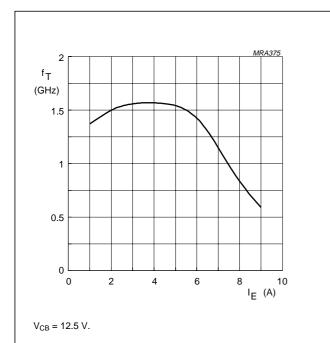


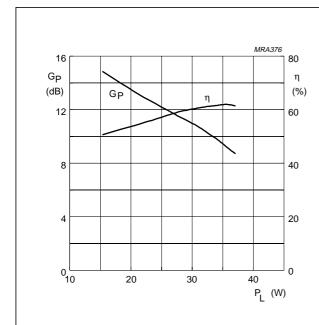
Fig.5 Transition frequency as a function of emitter current, typical values.

BLW30

APPLICATION INFORMATION

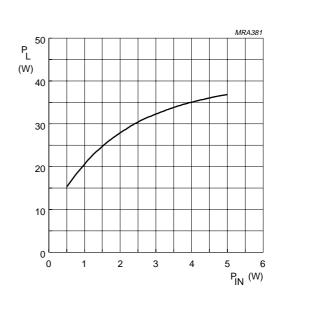
RF performance at T_{mb} = 25 °C in a common emitter test circuit.

| MODE OF OPERATION | f (MHz) | V _{CE} (V) | P _L (W) | G _P (dB) | ης (%) |
|-------------------|------------|------------------------|-----------------------|------------------------|------------------|
| c.w. class-B | 175 | 12.5 | 30 | > 10 | > 55 |
| | | | | typ. 11 | typ. 60 |



Class-B operation; $V_{CE} = 12.5 \text{ V}$; f = 175 MHz.

Fig.6 Gain and efficiency as functions of load power, typical values.



Class-B operation; $V_{CE} = 12.5 \text{ V}$; f = 175 MHz.

Fig.7 Load power as a function of drive power, typical values.

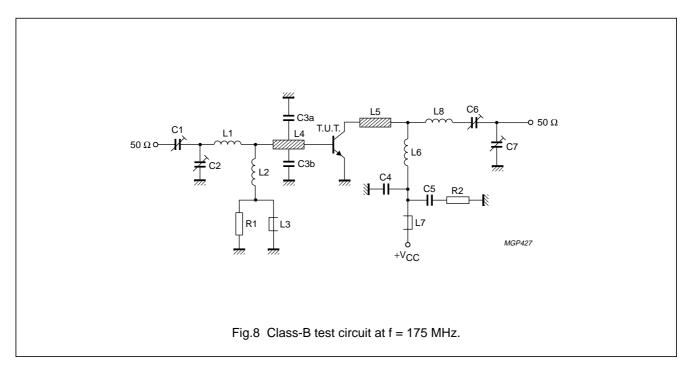
Ruggedness in class-B operation

The BLW30 is capable of withstanding a full load mismatch corresponding to VSWR = 50:1 through all phases at rated output power, up to a supply voltage of 15.5 V, and f = 175 MHz.

Philips Semiconductors Product specification

VHF power transistor

BLW30



List of components (see test circuit)

| COMPONENT | DESCRIPTION | VALUE | DIMENSIONS | CATALOGUE NO. |
|-----------|---|--------------|-----------------------------------|----------------|
| C1 | film dielectric trimmer | 2.5 to 20 pF | | 2222 809 07004 |
| C2, C7 | film dielectric trimmer | 4 to 40 pF | | 2222 809 07008 |
| C3a, C3b | 500 V ceramic capacitor | 47 pF | | |
| C4 | ceramic capacitor | 120 pF | | |
| C5 | polyester capacitor | 100 nF | | |
| C6 | film dielectric trimmer | 7 to 100 pF | | 2222 809 07015 |
| L1 | ½ turn enamelled 1.6 mm copper wire | | int. dia. 6 mm; leads 2 × 5 mm | |
| L2 | 7 turns closely wound enamelled 0.5 mm copper wire | 100 nH | int. dia. 3 mm; leads 2 × 5 mm | |
| L3, L7 | grade 3B Ferroxcube wideband HF choke | | | 4312 020 36640 |
| L4, L5 | stripline (note 1) | | 12 mm × 6 mm; note 2 | |
| L6 | 3½ turns closely wound enamelled 1.6 mm copper wire | | int. dia. 6 mm; leads 2 × 5 mm | |
| L8 | 1 turn enamelled 1.6 mm copper wire | | int. dia. 6 mm; leads 2 × 5 mm | |
| R1, R2 | 0.25 W carbon resistor | 10 Ω, 5% | | |

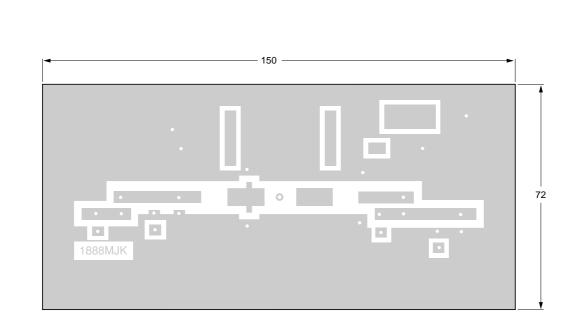
Notes

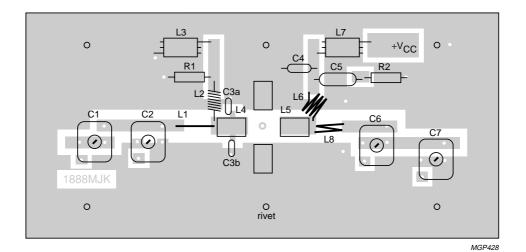
- 1. The striplines are on a double copper-clad printed circuit board, with epoxy fibre-glass dielectric, thickness $\frac{1}{16}$ inch.
- 2. Taps for capacitors C3a and C3b are situated 5 mm from the transistor.

Philips Semiconductors Product specification

VHF power transistor

BLW30

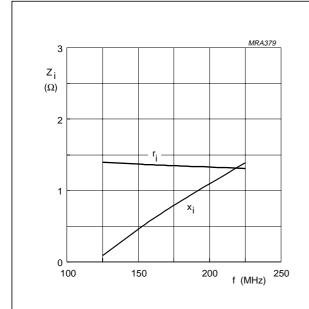




The circuit and components are situated on one side of an epoxy fibre-glass board; the other side is unetched and serves as a ground plane. Earth connections are made by means of hollow rivets and copper straps under the emitters, to provide a direct contact between the component side and the ground plane.

Fig.9 Component layout for 175 MHz class-B test circuit.

BLW30



Class-B operation; V_{CE} = 12.5 V; P_L = 30 W.

Fig.10 Input impedance (series components) as a function of frequency, typical values.

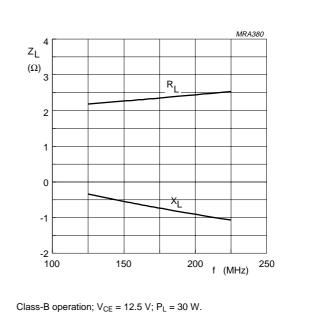
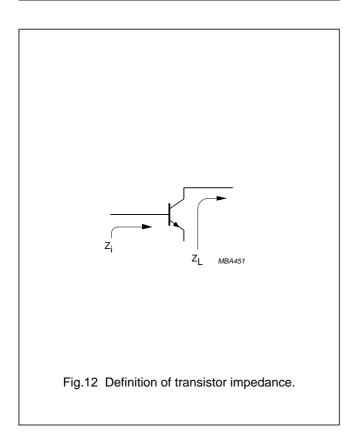
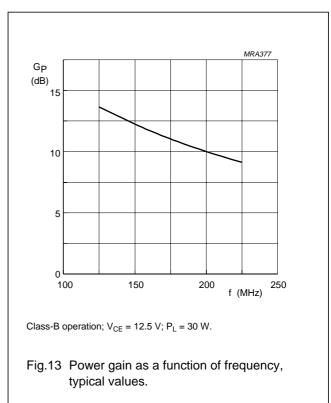


Fig.11 Load impedance (series components) as a function of frequency, typical values.



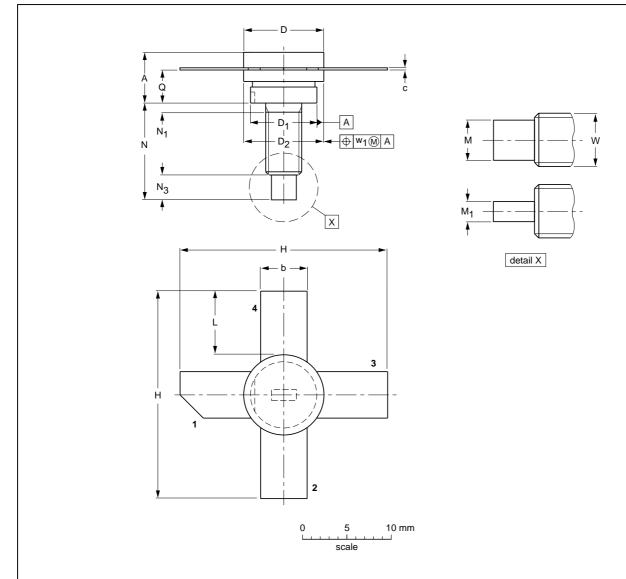


BLW30

PACKAGE OUTLINE

Studded ceramic package; 4 leads

SOT120A



${\color{red} \textbf{DIMENSIONS}} \ (\textbf{millimetre dimensions are derived from the original inch dimensions})$

| ι | JNIT | A | b | С | D | D ₁ | D ₂ | н | L | М | М1 | N | N ₁ | N ₃ | Q | w | w ₁ |
|----|------|----------------|----------------|--------------|--------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|--------------|------|----------------|
| | mm | 5.97 4.74 | 5.90 5.48 | 0.18 0.14 | 9.73 9.47 | 8.39 8.12 | 9.66 9.39 | 27.44 25.78 | 9.00 8.00 | 3.41 2.92 | 1.66 1.39 | 12.83 11.17 | 1.60 0.00 | 3.31 2.54 | 4.35 3.98 | 8-32 | 0.38 |
| ir | ches | 0.283 0.248 | 0.232 0.216 | | | 0.330 0.320 | 0.380 0.370 | | 0.354 0.315 | 0.134 0.115 | 0.065 0.055 | 0.505 0.440 | | 0.130 0.100 | | UNC | 0.015 |

| OUTLINE | | REFER | ENCES | EUROPEAN | ISSUE DATE |
|---------|-----|-------|-------|------------|------------|
| VERSION | IEC | JEDEC | EIAJ | PROJECTION | 1330E DATE |
| SOT120A | | | | | 97-06-28 |

Philips Semiconductors Product specification

VHF power transistor

BLW30

DEFINITIONS

| Data Sheet Status | |
|---------------------------|---|
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | • |

Limiting values

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.